

# Frequency limitation of an optimum performance class-E power amplifier

# Nam Ha-Van<sup>a)</sup>, Ninh Dang-Duy, Hyoungjun Kim, and Chulhun Seo<sup>b)</sup>

Information and Telecommunication Engineering, Soongsil University, 369 Sangdo-ro, Dongjak-gu, Seoul 156–743, Korea a) hanam.fet@gmail.com b) chulhun@ssu.ac.kr

**Abstract:** Class-E power amplifiers have found widespread application because of their design simplicity and high-efficiency operation. The nonlinear characteristic of the switching device significantly affects the power amplifier performance, although this is often neglected in theoretical analyses. In this paper, a class-E power amplifier with a shunt capacitance composed of nonlinear and linear capacitance has been mathematically analyzed to obtain the frequency limitation that governs maximum efficiency operation. The analytical method is presented to determine the effective operating frequency for any model of MOSFET device. The practical power amplifier circuit, using a MRF282 MOSFET, was implemented to verify the validity of the theoretical analysis.

**Keywords:** class-E, high efficiency, power amplifier (PA), nonlinear shunt capacitance, frequency limitation

Classification: Electron devices, circuits, and systems

## References

- [1] N. O. Sokal: IEEE MTT-S Int. Microw. Symp. Dig. (1998) 1109. DOI:10.1109/ MWSYM.1998.705187
- [2] N. O. Sokal and A. D. Sokal: IEEE J. Solid-State Circuits SC-10 (1975) 168. DOI:10.1109/JSSC.1975.1050582
- [3] A. Grebennikov and N. O. Sokal: *Switchmode RF Power Amplifiers* (Newnes, 2007) 2nd ed. 179.
- [4] Y. Park and H. Yoon: J. Electromagn. Eng. Sci. 15 [1] (2015) 53. DOI:10.5515/ JKIEES.2015.15.1.53
- [5] M. J. Chudobiak: IEEE Trans. Circuit Syst. I, Fundam. Theory Appl. 41 (1994) 941. DOI:10.1109/81.340867
- [6] H. V. Nam and C. Seo: IEICE Electron. Express 11 (2014) 20140682. DOI: 10.1587/elex.11.20140682
- [7] P. Alinikula, K. Choi and S. I. Long: IEEE Trans. Circuit Syst. II, Analog Digit. Signal Process. 46 (1999) 114. DOI:10.1109/82.752911
- [8] X. Wei, H. Sekiya, S. Kuroiwa, T. Suetsugu and M. K. Kazimierczuk: IEEE Trans. Circuits Syst. I, Reg. Papers 58 (2011) 2556. DOI:10.1109/TCSI.2011. 2123490
- [9] A. Mediano, P. M. Gaudó and C. Bernal: IEEE Trans. Microw. Theory Techn.





**55** (2007) 484. DOI:10.1109/TMTT.2006.890512

 [10] T. Suetsugu and M. K. Kazimierczuk: IEEE Trans. Circuits Syst. I, Reg. Papers 51 (2004) 1261. DOI:10.1109/TCSI.2004.830695

# 1 Introduction

Power amplifier (PA) systems are required to reduce power consumption significantly so as to maximize the system performance. Power added efficiency (PAE) is the most important factor by which such performance is validated. The switchmode amplifier structure has been proposed for obtaining high efficiency; the switch-mode class-E amplifier with a shunt capacitor produced by Sokal has an efficiency that, theoretically, reaches up to 100% [1, 2, 3, 4]. However, the operation of the linear shunt-capacitance class-E amplifier in theoretical analysis is different from that of an actual class-E amplifier. The parasitic drain-to-source capacitance of the switch device is nonlinear, which contributes significantly to the overall shunt capacitance in the operation [5, 6, 7]. Therefore, it is necessary to take into account the nonlinear behavior of this capacitance.

In this paper, the class-E power amplifier circuit is analyzed, and its design is based of the composition of nonlinear and linear shunt capacitance. The zero-voltage-switching (ZVS) and zero-derivative-switching (ZDS) conditions are satisfied, which ensure zero switching loss and improve component tolerances [8, 9]. Furthermore, in order to design an accurate power amplifier circuit, it is necessary to consider adequately the frequency limitation of an active device. As such, the metal-oxide-semiconductor field-effect transistor (MOSFET) possesses an intrinsic output capacitance, and together with the given dc supply voltage and output power, the operating frequency limitation should be determined if the amplifier is to maintain maximum efficiency operation. If the operating frequency exceeds the limited value, the class-E amplifier cannot satisfy the ZVS and ZDS conditions. The objective of this paper is to present an expression for the frequency limitation of the MOSFET class-E power amplifier composed of linear and nonlinear shunt capacitances. In addition, an example design has been implemented to validate the influence of the frequency selection on the optimized performance.

# 2 Frequency limitation of class-E amplifiers

In [10], Tadashi Suetsugu proposed an analysis method and design for class-E amplifiers with both linear and nonlinear shunt capacitances. The supporting figures and tables that contain results of a numerical analysis of the design equations are used to extract the component values for the class-E amplifier. However, the design equations of an arbitrary MOSFET depend on its own parameters, such as the output capacitance, the reverse transfer capacitance of the transistor, etc. Therefore, in order to design such a class-E power amplifier, the equations should be solved for a certain MOSFET. In this section, we re-analyze the circuit mathematically to derive the parameters for the class-E amplifier, and extract the component values and the highest operation frequency.





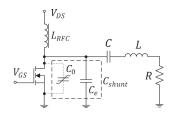


Fig. 1. Basic circuit of the class-E PA.

A conventional circuit of the class-E amplifier with a shunt capacitance is illustrated in Fig. 1. This circuit includes a dc-supply drain voltage  $V_{DS}$ , a gate voltage  $V_{GS}$ , a choke inductor  $L_{RFC}$ , a MOSFET as a switch device, the series resonant RLC circuit, the shunt capacitance consisting of the MOSFET drain-to-source capacitance  $C_0$ , and the external linear capacitance  $C_e$ . The total shunt capacitance of the class-E power amplifier circuit is described by:

$$C_{shunt} = C_0 + C_e = \frac{C_{j0}}{\sqrt{1 + \frac{v_S}{V_{bi}}}} + C_e$$
(1)

where  $C_{j0}$  is the shunt capacitance at the drain-to-source voltage  $v_S = 0$  V and  $V_{bi}$  is the built-in potential of the MOSFET body diode.

The switch voltage is supposed to satisfy the ZVS condition at the turn-on period. Because the dc voltage across the choke inductor  $L_{RFC}$  is zero, the average value of the switch voltage is equal to the dc supply voltage  $V_{DS}$ :

$$V_{DS} = \frac{1}{2\pi} \int_0^{2\pi} v_S(\theta) d\theta \tag{2}$$

where  $v_S$  is the drain-to-source voltage. When the switch is off (i.e., for  $0 < \theta = \omega t \le \pi$ ),  $v_S$  can be extracted from the integration of the drain current equation:

$$\omega \int_0^{v_S} \left( \frac{C_{j0}}{\sqrt{1 + \frac{v_S}{V_{bi}}}} + C_e \right) dv_S = \int_0^\theta i_C d\theta \tag{3}$$

Substituting  $v_S$  into Eq. (2), then, partly expanding as follows, yields:

$$\frac{V_{DS}}{V_{bi}} = \frac{\alpha}{\pi} \left[ \pi (\alpha + \beta \sin \phi \cos \phi + 1) + \beta \left( \frac{\pi^2}{2} + 2 \right) \sin^2 \phi \right] - \frac{\alpha}{\pi} \int_0^{\pi} [\alpha^2 + 2\alpha + 1 + 2\alpha\beta \sin \phi \cos \phi + 2\alpha\beta\theta \sin^2 \phi - 2\alpha\beta \sin \phi \cos(\theta + \phi)]^{\frac{1}{2}} d\theta$$
(4)

where:

$$\alpha = \frac{C_{j0}}{C_e} \tag{5}$$

$$\beta = \frac{(\pi^2 + 4)P_o}{16\pi f_o C_{j0} V_{bi} V_{DS}}$$
(6)

and  $\phi$  is the phase difference between input and output signals.

EiC



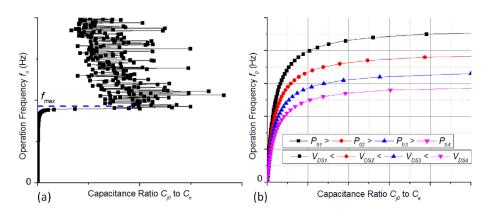


Fig. 2. (a) Operation frequency as a function of capacitance ratio; (b) The dependence of operation frequency  $f_o$  on various  $V_{DS}$  and  $P_o$  values.

The relation between the frequency  $f_o$  and the given parameters, including the capacitance ratio  $\alpha$  of  $C_{jo}$  to  $C_e$ , the dc supply voltage  $V_{DS}$ , and the output power  $P_o$  is demonstrated in Eq. (4), which could not be integrated to obtain an analytical solution. The solution is plotted in Fig. 2(a), which depicts the dependence of the operating frequency  $f_o$  upon  $\alpha$  for the given values of  $V_{DS}$  and  $P_o$ . It is obvious that the dependence of  $f_o$  on  $\alpha$  is represented in two regions: the linear dependence region and the *perturbation* dependence region. In the former region, each value of  $\alpha$  corresponds to only one frequency  $f_o$ , which satisfies the boundary conditions for maintaining the optimized performance of a class-E amplifier. Consequently, the external capacitance  $C_e$  can be obtained from the capacitance ratio  $\alpha$  by calculating the junction capacitance  $C_{j0}$ , as in the following equation [10]:

$$C_{j0} = (C_{oss} - C_{rss}) \sqrt{1 + \frac{25}{V_{bi}}}$$
(7)

where  $C_{oss}$  and  $C_{rss}$  are the output capacitance and reverse transfer capacitance of the transistor, respectively, and which are often provided in the manufacturer catalogs of power MOSFETs. In Eq. (4), the junction capacitance  $C_{j0}$  is a variable of  $\beta$ , which depends on the parasitic parameters of the specific transistor. Therefore, the solution of Eq. (4) is only derived for the specific transistor, which has the extracted junction capacitance  $C_{j0}$ .

In contrast, the dependence between  $f_o$  and  $\alpha$  is extraordinary in the perturbation region. It is conducive to the irrelevant determination of accurate operation frequency. The separation of these regions is distinguished by the maximum frequency,  $f_{max}$ , which is the frequency limitation for the MOSFET class-E power amplifier. It may be seen that the decline in the value of  $C_{jo}$  leads to the increment of  $f_{max}$  with the same conditions and vice versa. Therefore, based on the highest operation frequency derived for the given MOSFET, the frequency can be chosen to provide the highest efficiency within the methodology of class-E design.

In addition, it is shown that the maximum operating frequency of the class-E power amplifier can be changed by varying the given supply voltage and the given output power. Fig. 2(b) shows the relation between the frequency  $f_o$  and the various  $V_{DS}$  and  $P_o$  values. The increased drain voltage results in the decrease of





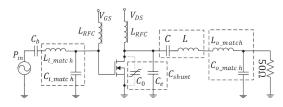


Fig. 3. Completed class-E power amplifier circuit.

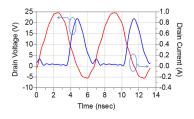


Fig. 4. Drain current and voltage simulation waveforms of a class-E power amplifier circuit.

the maximum frequency; whereas, the latter will increase if the output power increases. Based on these relations, the output power and supply voltage need to be properly appointed so that the drain-to-source current,  $I_{DS} = P_o/V_{DS}$ , does not surpass through the active device. A high  $I_{DS}$  value leads to an increase in the thermal effects caused by the parasitic saturation resistances of the transistor.

#### 3 Circuit design and measurement

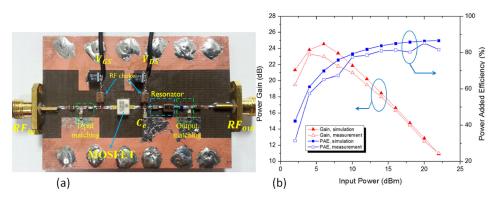
The proposed techniques for finding the operation frequency limitation were validated by fabricating a class-E PA using a MRF282 MOSFET. From the analysis in the previous section, the schematic of the completed class-E PA circuit is modeled in Fig. 3. The class-E PA circuit is implemented with a selected operation frequency,  $f_o$ , lower than the maximum frequency,  $f_{max}$ . Moreover, the highest operation frequency,  $f_{max}$ , of approximately 170 MHz is derived by substituting the appropriate parameters into Eq. (4). The designed class-E PA at an operating frequency,  $f_o$ , of 150 MHz has a high PAE of 85.3% for a supply voltage of 6 V and an output power of 2 W.

The voltage and current simulation waveforms are depicted in Fig. 4 under the optimum operation; they overlap each other slightly, resulting in a minimized power dissipation by the transistor. The voltage across the switching device is presumed to satisfy the ZVS and ZDS conditions. Fig. 5(a) presents the experimental fabrication for the proposed circuit. Fig. 5(b) shows the comparison between the simulated and experimental results of the gain and PAE, which are in good agreement. The power gain and PAE of the experimental results are slightly lower than the simulation results.

A design of the class-E PA circuit with an operation frequency higher than the maximum frequency was fabricated to compare its performance with the proposed circuit, as shown in Table I. From these values, it is clear that the class-E PA with a high frequency of 180 MHz is achieves low efficiency and low output power. Using the same given parameters as before, the output power in this case is insufficient as the expected power, followed by the low efficiency of 72% PAE. In addition, the







**Fig. 5.** (a) The fabrication of the class-E power amplifier; (b) Gain and PAE results in simulation and measurement.

Parameters	Proposed Design	Compared Design
$V_{DS}$ (V)	6	6
$V_{GS}$ (V)	3.2	3.2
$I_{DS}$ (mA)	368	440
$I_{GS}$ (mA)	0	0
$C_e (pF)$	3.3	0.5
$f_o$ (MHz)	150	180
$P_{in}$ (dBm)	20.5	20.5
$P_o$ (dBm)	33	32.5
PAE (%)	85.3	72

Table I. Comparison results

drain-to-source current increases strongly, which is conducive to the dissipation of power by thermal loss from the parasitic saturation resistance. Consequently, the operating frequency for a class-E PA using a MOSFET should be appointed restrictively to achieve the high performance with the composition of linear and nonlinear shunt capacitances.

#### 4 Conclusion

This paper has presented the analytical method for deriving the maximum operation frequency for a MOSFET class-E PA with linear and nonlinear shunt capacitance composition. The relation between the operation frequency and the given parameters, including supply voltage and output power, is taken into account in detail. The practical class-E PA circuit was fabricated to verify the accurate frequency selection for the arbitrary MOSFET.

## Acknowledgments

This work was supported by the Human Resources Development program (No. 20144030200600) of the Korea Institute of Energy Technology Evaluation and Planning (KETEP); a grant funded by the Korea government Ministry of Trade, Industry and Energy; and also by Basic Research Laboratories (BRL) through an NRF grant funded by the MSIP (No. 2015056354).

